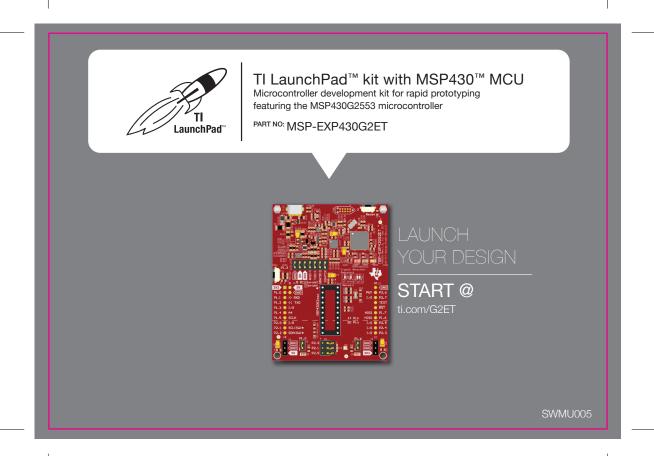
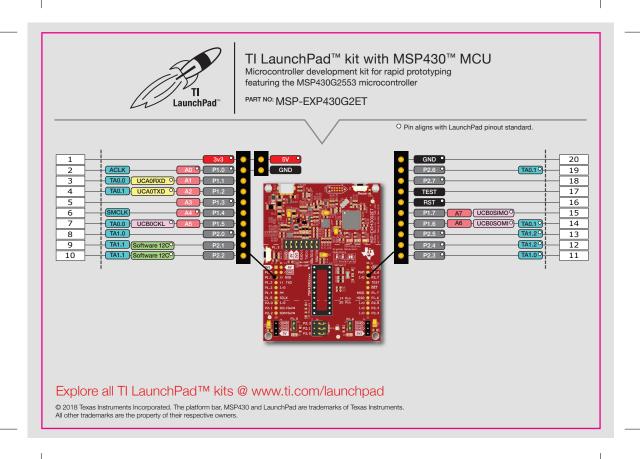
LaunchPad QuickStart Guide (QSG) MSP-EXP430G2ET

FRONT



A6 paper (105 x 148 mm / 4.1 x 5.8 in) Background color: #115566ff

BACK



A6 paper (105 x 148 mm / 4.1 x 5.8 in) Background color: #e0e0e0ff

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